

## N-Channel Enhancement Mode Field Effect Transistor

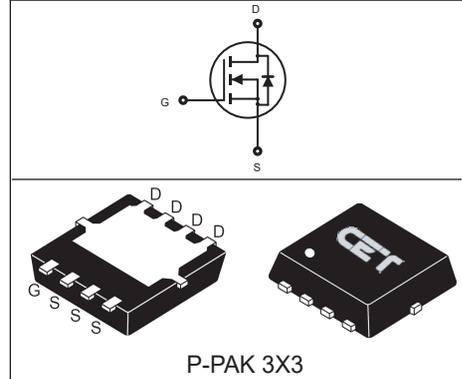
### FEATURES

- High power and current handling capability.
- Reliable and rugged.
- Pb-free lead plating ; RoHS compliant.
- Halogen Free.

### APPLICATIONS

- DC/DC Converters.
- Load Switch.
- Battery Powered Systems.

$V_{DSS}$	$R_{DS(ON) typ @V_{GS}}$	$I_D$
30V	2.7m $\Omega$ @ $V_{GS} = 10V$	66A



### ABSOLUTE MAXIMUM RATINGS $T_C = 25^\circ C$ unless otherwise noted

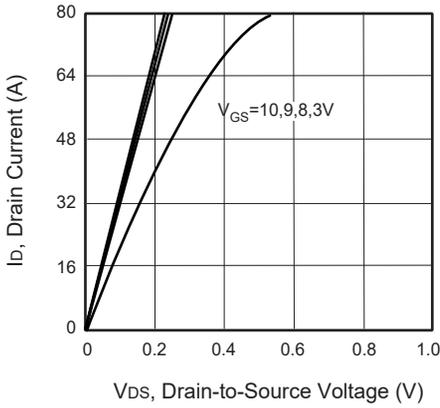
Parameter		Symbol	Limit	Units
Drain-Source Voltage		$V_{DS}$	30	V
Gate-Source Voltage		$V_{GS}$	$\pm 20$	V
Drain Current-Continuous	$I_D @R_{\theta JC}$	$T_C = 25^\circ C$	66	A
		$T_C = 70^\circ C$	53	A
	$I_D @R_{\theta JA}$	$T_A = 25^\circ C$	21	A
		$T_A = 70^\circ C$	17	A
Drain Current-Pulsed <sup>a</sup>	$I_{DM} @R_{\theta JC}$	$T_C = 25^\circ C$	264	A
	$I_{DM} @R_{\theta JA}$	$T_A = 25^\circ C$	84	A
Maximum Power Dissipation		$P_D$	25	W
Single Pulsed Avalanche Energy <sup>d</sup>		$E_{AS}$	144	mJ
Single Pulsed Avalanche Current <sup>d</sup>		$I_{AS}$	17	A
Operating and Store Temperature Range		$T_J, T_{stg}$	-55 to 150	$^\circ C$

### Thermal Characteristics

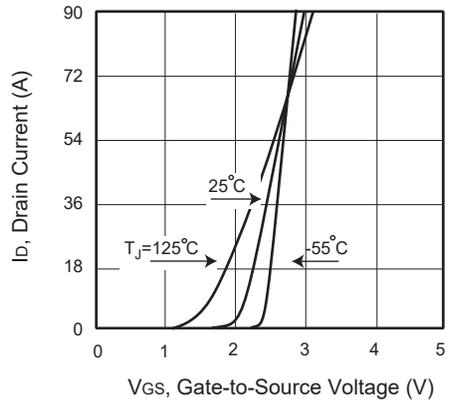
Parameter	Symbol	Limit	Units
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	5	$^\circ C/W$
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	50	$^\circ C/W$

## Electrical Characteristics $T_C = 25^\circ\text{C}$ unless otherwise noted

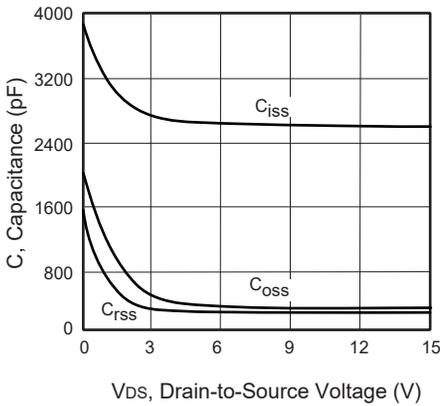
Parameter	Symbol	Test Condition	Min	Typ	Max	Units
<b>Off Characteristics</b>						
Drain-Source Breakdown Voltage	$BV_{DSS}$	$V_{GS} = 0V, I_D = 250\mu A$	30			V
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = 30V, V_{GS} = 0V$			1	$\mu A$
Gate Body Leakage Current, Forward	$I_{GSSF}$	$V_{GS} = 20V, V_{DS} = 0V$			100	nA
Gate Body Leakage Current, Reverse	$I_{GSSR}$	$V_{GS} = -20V, V_{DS} = 0V$			-100	nA
<b>On Characteristics<sup>b</sup></b>						
Gate Threshold Voltage	$V_{GS(th)}$	$V_{GS} = V_{DS}, I_D = 250\mu A$	1		3	V
Static Drain-Source On-Resistance	$R_{DS(on)}$	$V_{GS} = 10V, I_D = 20A$		2.7	3.2	$m\Omega$
		$V_{GS} = 4.5V, I_D = 15A$		3.1	4.0	$m\Omega$
Gate input resistance	$R_g$	$f = 1MHz, \text{open Drain}$		3.3		$\Omega$
<b>Dynamic Characteristics<sup>c</sup></b>						
Input Capacitance	$C_{iss}$	$V_{DS} = 15V, V_{GS} = 0V, f = 1.0 MHz$		2585		pF
Output Capacitance	$C_{oss}$			335		pF
Reverse Transfer Capacitance	$C_{rss}$			280		pF
<b>Switching Characteristics<sup>c</sup></b>						
Turn-On Delay Time	$t_{d(on)}$	$V_{DD} = 15V, I_D = 10A, V_{GS} = 10V, R_{GEN} = 4.7\Omega$		23		ns
Turn-On Rise Time	$t_r$			12		ns
Turn-Off Delay Time	$t_{d(off)}$			57		ns
Turn-Off Fall Time	$t_f$			30		ns
Total Gate Charge	$Q_g$	$V_{DS} = 15V, I_D = 10A, V_{GS} = 4.5V$		24		nC
Gate-Source Charge	$Q_{gs}$			5		nC
Gate-Drain Charge	$Q_{gd}$			13		nC
<b>Drain-Source Diode Characteristics and Maximum Ratings</b>						
Drain-Source Diode Current-Continuous	$I_S$				29	A
Drain-Source Diode Current-Pulsed <sup>b</sup>	$I_{SM}$				264	A
Drain-Source Diode Forward Voltage <sup>b</sup>	$V_{SD}$	$V_{GS} = 0V, I_S = 1A$			1.2	V
<b>Notes :</b> a.Repetitive Rating : Pulse width limited by maximum junction temperature. b.Pulse Test : Pulse Width $\leq 300\mu s$ , Duty Cycle $\leq 2\%$ . c.Guaranteed by design, not subject to production testing. d.L = 1mH, $I_{AS} = 17A, V_{DD} = 24V, R_G = 25\Omega$ , Starting $T_J = 25^\circ\text{C}$ .						



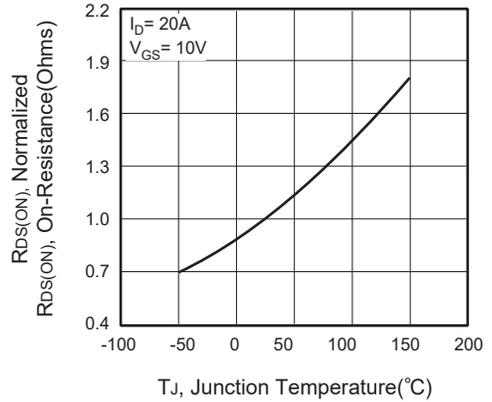
**Figure 1. Output Characteristics**



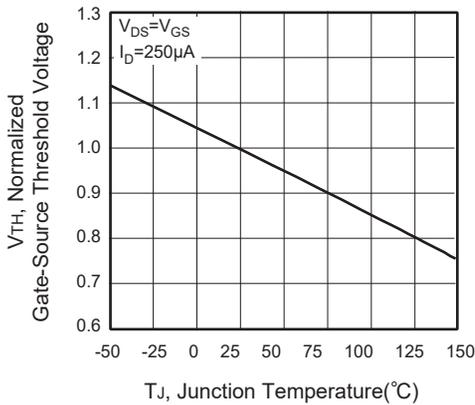
**Figure 2. Transfer Characteristics**



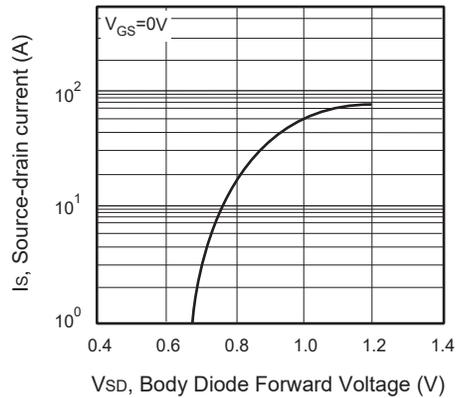
**Figure 3. Capacitance**



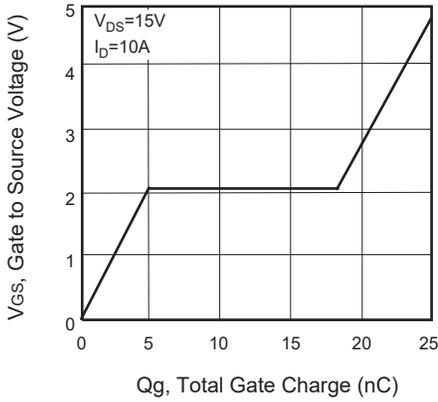
**Figure 4. On-Resistance Variation with Temperature**



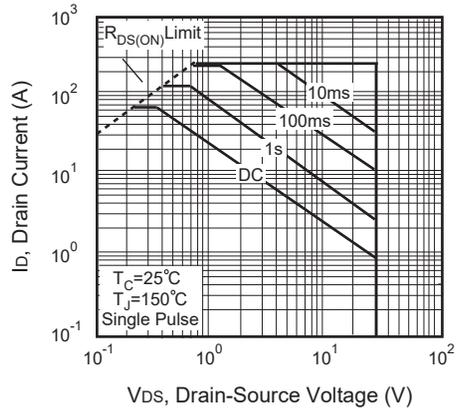
**Figure 5. Gate Threshold Variation with Temperature**



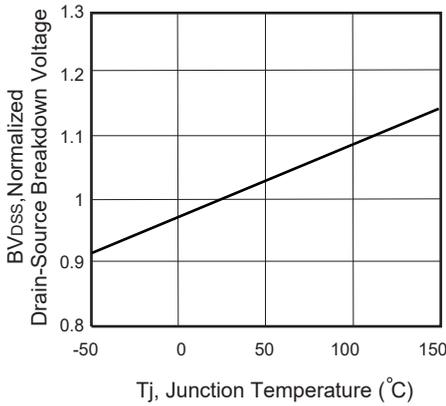
**Figure 6. Body Diode Forward Voltage Variation with Source Current**



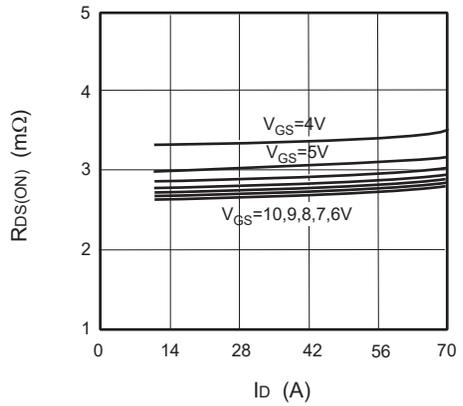
**Figure 7. Gate Charge**



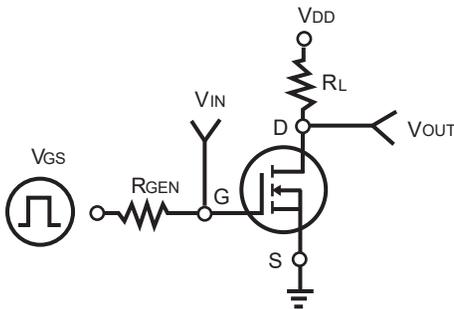
**Figure 8. Maximum Safe Operating Area**



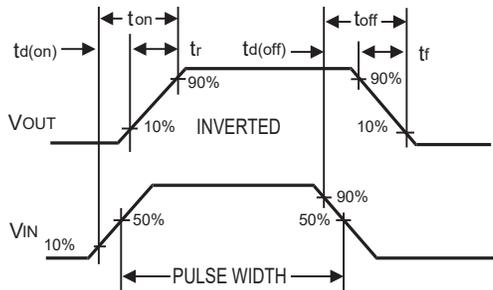
**Figure 9. Breakdown Voltage Variation VS Temperature**



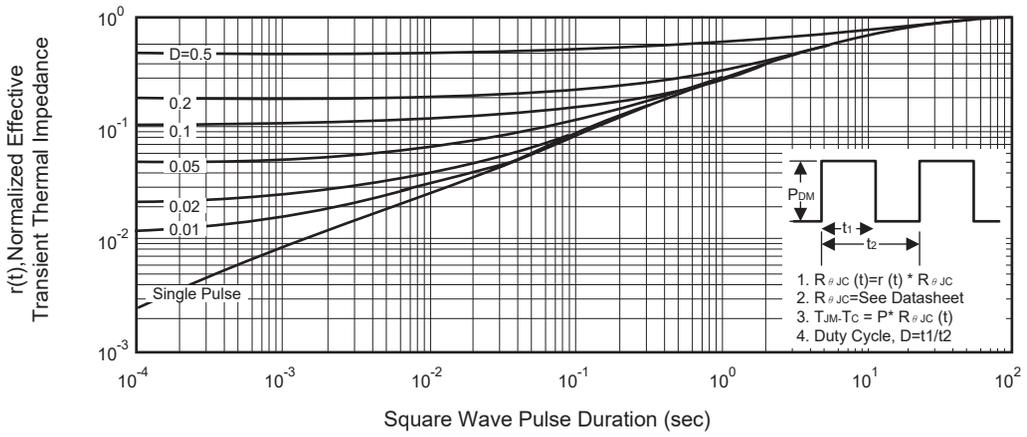
**Figure 10. On-Resistance VS Drain Current**



**Figure 11. Switching Test Circuit**



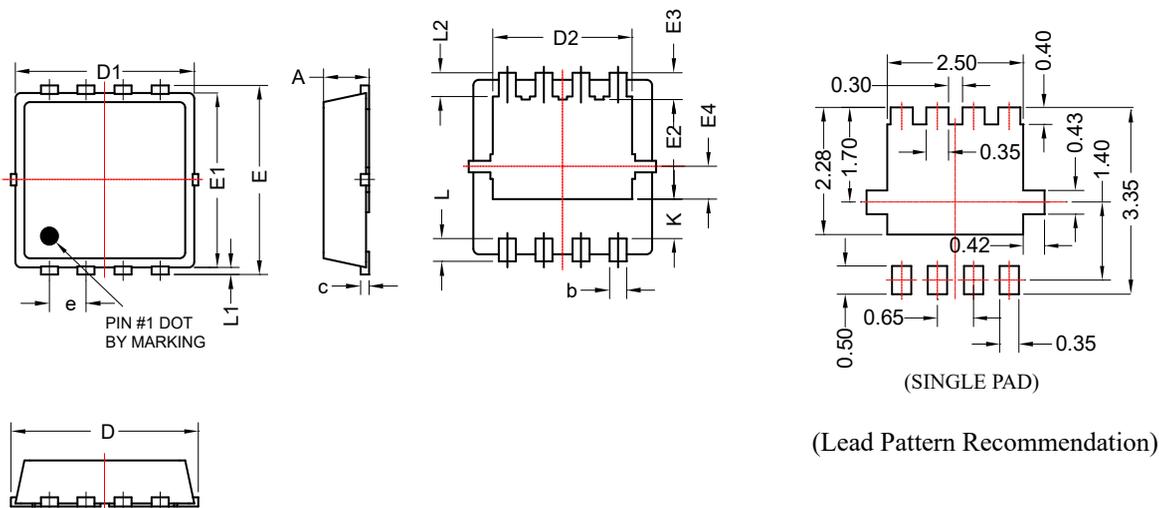
**Figure 12. Switching Waveforms**



**Figure 13. Normalized Thermal Transient Impedance Curve**

## P-PAK 3X3 產品外觀尺寸圖 (Product Outline Dimension)

### SINGLE PAD 尺寸圖



SYMBOLS	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	0.7	0.85	0.028	0.033
b	0.20	0.40	0.008	0.016
c	0.10	0.25	0.004	0.010
D	3.15	3.45	0.124	0.136
D1	3.00	3.25	0.118	0.128
D2	2.29	2.65	0.090	0.104
E	3.15	3.45	0.124	0.136
E1	2.90	3.20	0.114	0.126
E2	1.54	1.94	0.061	0.076
E3	0.28	0.65	0.011	0.026
E4	0.37	0.77	0.015	0.030
e	0.65(BSC)		0.026(BSC)	
K	0.50	0.89	0.02	0.035
L	0.30	0.50	0.012	0.020
L1	0.06	0.20	0.002	0.008
L2	0.27	0.57	0.011	0.022